

## [Product Information]

# IMX307LQD/LQR

Ver.1.0

Diagonal 6.46 mm (Type 1/2.8) CMOS Solid-state Image Sensor with Square Pixel for Color Cameras

### Description

The IMX307LQD/LQR are diagonal 6.46 mm (Type 1/2.8) CMOS active pixel type solid-state image sensors with a square pixel array and 2.13 M effective pixels. These chips operate with analog 2.9 V, digital 1.2 V, and interface 1.8 V triple power supply, and have low power consumption. High sensitivity, low dark current and no smear are achieved through the adoption of R, G and B primary color mosaic filters. These chips feature an electronic shutter with variable charge-integration time.

(Applications: Surveillance cameras, FA cameras, Industrial cameras)

### Features

- ◆ CMOS active pixel type dots
- ◆ Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆ Input frequency: 74.25 MHz / 37.125 MHz
- ◆ Number of recommended recording pixels: 1920 (H) × 1080 (V) approx. 2.07M pixel
- ◆ Readout mode
  - All-pixel scan mode
  - 720p-HD readout mode
  - Window cropping mode
  - Vertical / Horizontal direction-normal / inverted readout mode
- ◆ Readout rate
  - Maximum frame rate in Full HD 1080p mode: 60 frame / s
- ◆ High dynamic range (HDR) function
  - Multiple exposure HDR
  - Digital overlap HDR
- ◆ Variable-speed shutter function (resolution 1H units)
- ◆ 10-bit / 12-bit A/D converter
- ◆ CDS / PGA function
  - 0 dB to 27 dB: Analog Gain 27 dB (step pitch 0.3 dB)
  - 27.3 dB to 69 dB: Analog Gain 27 dB + Digital Gain 0.3 to 42 dB (step pitch 0.3 dB)
- ◆ Supports I/O switching
  - Low voltage LVDS (150 m Vp-p) serial ( 2 ch / 4 ch switching) DDR output
  - CSI-2 serial data output ( 2 Lane / 4 Lane, RAW10 / RAW12 output)
- ◆ Recommended exit pupil distance: -30 mm to  $-\infty$

### STARVIS

\* STARVIS is a trademark of Sony Corporation. The STARVIS is back-illuminated pixel technology used in CMOS image sensors for surveillance camera applications. It features a sensitivity of 2000 mV or more per  $1 \mu\text{m}^2$  (color product, when imaging with a  $706 \text{ cd/m}^2$  light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

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**Device Structure**

◆ CMOS image sensor	
◆ Image size	Type 1/2.8
◆ Total number of pixels	1945 (H) × 1109 (V) approx. 2.16 M pixels
◆ Number of effective pixels	1945 (H) × 1097 (V) approx. 2.13 M pixels
◆ Number of active pixels	1937 (H) × 1097 (V) approx. 2.12 M pixels
◆ Number of recommended recording pixels	1920 (H) × 1080 (V) approx. 2.07 M pixels
◆ Unit cell size	2.9 μm (H) × 2.9 μm (V)
◆ Optical black	Horizontal (H) direction: Front 0 pixels, rear 0 pixels Vertical (V) direction: Front 10 pixels, rear 0 pixels
◆ Dummy	Horizontal (H) direction: Front 0 pixels, rear 3 pixels Vertical (V) direction: Front 0 pixels, rear 0 pixels
◆ Package	112 pin BGA (IMX307LQD), 110 pin LGA (IMX307LQR)

**Image Sensor Characteristics**

(Tj = 60 °C)

Item		Value	Remarks
Sensitivity (F5.6)	Typ.	7757 Digit	1/30s accumulation 12 bit converted value
Saturation signal	Min.	3854 Digit	12 bit converted value

**Basic Drive Mode**

Drive mode	Recommended number of recording pixels	Maximum frame rate [frame/s]	Output interface	ADC [bit]
Full HD 1080p	1920 (H) × 1080 (V) approx. 2.07M pixels	60	LVDS CSI-2	10/12
HD 720p	1280 (H) × 720 (V) approx. 0.92M pixels	60	LVDS CSI-2	10/12